

Serial No.: 09/853,784
Art Unit: 2826

Attorney's Docket No.: KIX0146-US
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IN THE CLAIMS:

Please amend claim 1 as shown in the attached sheet(s).

REPLACEMENT CLAIMS

Please substitute the following claims for the pending claims with the same number.

1. (Twice Amended) A semiconductor device comprising:

a semiconductor chip;

an external connection electrode connected to the chip; and

a resin package which covers the chip and has a mounting surface;

wherein the electrode includes a thick portion and a thin portion, the thick portion being exposed to outside only at the mounting surface of the package, the thick portion being not exposed at any other surface of the package.